

FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- Low forward voltage drop, High current capability
- Soft recovery improves EMC performance
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2015\863\EU

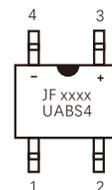
MECHANICAL DATA

- Case:ABS molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750,method 2026
- Mounting Position: Any

TYPICAL APPLICATIONS

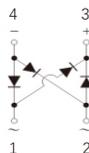
Used in AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, charger, home appliances, office equipment, and telecommunication applications.

ABS



Pin Diagram

Marking
JF:Logo
XXXX:Data code
UABS4:Type



Internal Schematic

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25 °C ambient temperature unless otherwise specified. Single phase ,half wave ,60Hz,resistive or inductive load. For capacitive load,derate current by 20%.)

| Parameters | | Symbols | Value | Units |
|--|--------------------|-----------------|-------------|------------------|
| Maximum Recurrent Peak Reverse Voltage | | V_{RRM} | 400 | Volts |
| Maximum RMS Voltage | | V_{RMS} | 280 | Volts |
| Maximum DC Blocking Voltage | | V_{DC} | 400 | Volts |
| Maximum Average Forward Rectified Current | | $I_{(AV)}$ | 1.0 | Amps |
| Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method) | | I_{FSM} | 30 | Amps |
| Rating for fusing (t=8.3ms) | | I^2t | 3.735 | A ² s |
| Maximum DC Reverse Current at rated DC blocking voltage | $T_A=25^{\circ}C$ | I_R | 5 | μA |
| | $T_A=125^{\circ}C$ | | 100 | |
| Maximum Instantaneous Forward Voltage at 1.0A | | V_F | 1.3 | Volts |
| Typical thermal resistance(Note2) | | $R_{\theta JA}$ | 62.5 | $^{\circ}C/W$ |
| | | $R_{\theta JL}$ | 25 | |
| Maximum reverse recovery time(Note1) | | t_{rr} | 50 | ns |
| Operating junction and storage temperature range | | T_J, T_{STG} | -55 to +150 | $^{\circ}C$ |

Note: 1.Test conditions: IF=0.5A,IR=1.0A,IRR=0.25A.

2.Device mounted on FR-4 substrate, 1"*1", 2oz, single-sided, PC boards with 0.56"*0.73" copper pad.

AVAILABLE PACK INFORMATION

| Product code | Pack | Reel Size (mm) | Quantity (pcs/reel) | Quantity (reel/box) | Quantity (box/carton) | Quantity (K/carton) |
|--------------|------|----------------|---------------------|---------------------|-----------------------|---------------------|
| UABS4-ABS | T/R | Φ330 | 3000 | 2 | 8 | 48 |

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

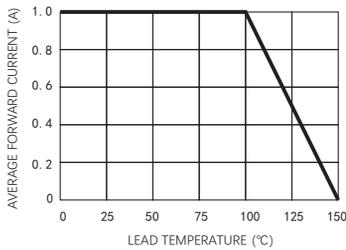


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

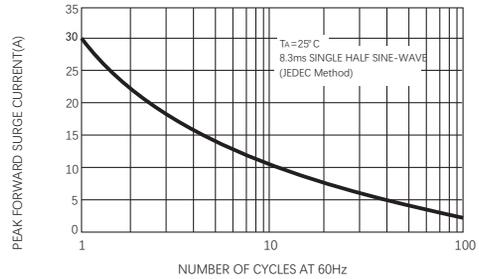


FIG.3-TYPICAL REVERSE CHARACTERISTICS

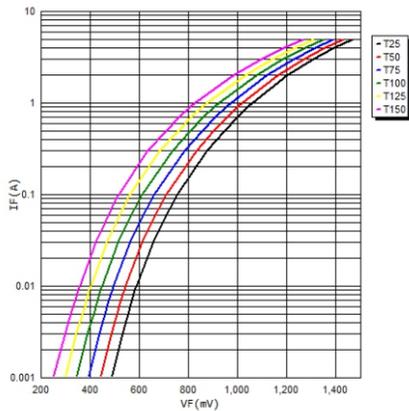


FIG4-TYPICAL FORWARD CHARACTERISTICS

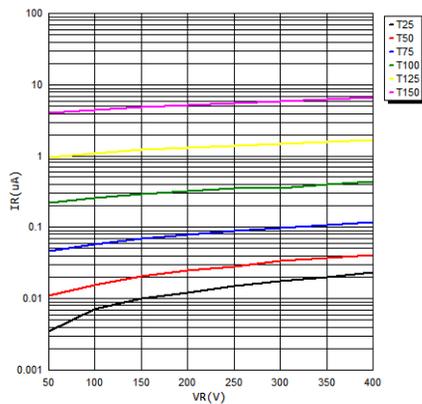
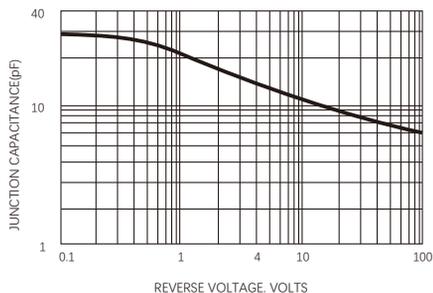
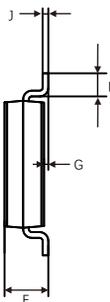
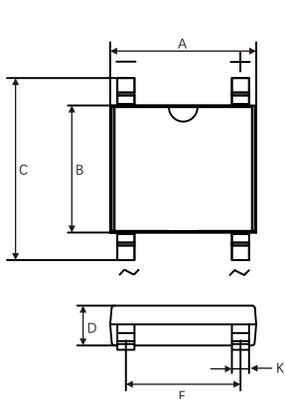


FIG.5-TYPICAL JUNCTION CAPACITANCE



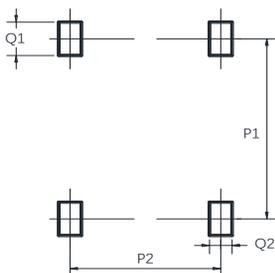
PACKAGE OUTLINE DIMENSIONS

ABS



| UNIT:mm | | |
|---------|------|------|
| DIM | MIN | MAX |
| A | 4.80 | 5.40 |
| B | 4.20 | 4.60 |
| C | 6.00 | 6.80 |
| D | 1.20 | 1.50 |
| E | 3.80 | 4.40 |
| F | 1.22 | 1.60 |
| G | 0.05 | 0.15 |
| I | 0.30 | 0.80 |
| J | 0.10 | 0.30 |
| K | 0.50 | 0.85 |

Suggested solder pad layout



| Dim | Min |
|-----|------|
| P1 | 5.72 |
| P2 | 4.00 |
| Q1 | 1.00 |
| Q2 | 0.90 |

Dimensions in millimeters

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